PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Satoshi TAKAHASHI	07/04/2011
Tsuyoshi SONEHARA	07/06/2011
Tomoyuki SAKAI	07/06/2011
Takanobu HAGA	07/07/2011
Hirokazu KATO	07/09/2011
Nobutaka KUMAZAKI	07/09/2011
Takuya MATSUI	07/05/2011

RECEIVING PARTY DATA

Name:	Hitachi High-Technologies Corporation	
Street Address:	24-14, Nishi Shinbashi 1-chome, Minato-ku,	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	13147147	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 062758-0313

NAME OF SUBMITTER: Keith E. George

Total Attachments: 2

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PATENT REEL: 026675 FRAME: 0070 13147147

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RECORDATION FORM	1 COVER SHEET			
Docket No.: 062758-0313 PATENTS ONLY				
To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.				
1. Name of Conveying Party(ies)	2. Name and address of receiving party(ies)			
Satoshi TAKAHASHI, Tsuyoshi SONEHARA, Tomoyuki	Name: Hitachi High-Technologies Corporation			
SAKAI, Takanobu HAGA, Hirokazu KATO, Nobutaka				
KUMAZAKI, Takuya MATSUI				
, •	Internal Address:			
Additional name(s) of conveying party(ies) attached? \(\subseteq \text{Yes} \subseteq \text{No} \)				
3. Nature of Conveyance/Execution Date(s)	Address: 24-14, Nishi Shinbashi 1-chome, Minato-ku,			
	Tokyo, Japan			
Execution Date(s): July 4, 2011; July 6, 2011; July 6, 2011;				
July 7, 2011; July 9, 2011; July 9, 2011				
and July 5, 2011 respectively				
Security Agreement Change of Name				
Joint Research Agreement				
Government Interest Assignment				
4. Application or patent number(s):	☐ This document is being filed together with a new application.			
A. Patent Application No(s).	B. Patent No(s).			
5. Name and address to whom correspondence concerning	6. Total number of applications and patents			
document should be mailed:	involved:			
Name: MCDERMOTT WILL & EMERY LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00			
Internal Address:	Authorized to be charged by credit card			
	Authorized to be charged to deposit account			
Street Address: 600 13th Street, N.W.	Enclosed			
	None required (government interest not affecting title)			
City: Washington, State: DC Zip: 20005-3096				
D.C.				
Phone Number: 202.756.8000	8. Payment Information:			
Fax Number: 202.756.8087				
Email Address:	a. Credit Card Last 4 Numbers Expiration Date			
	b. Deposit Account Number 500417			
	Authorized User Name			
9. Signature.	1456			
Keith E. George 34,111	July 29, 2011			
Name and Registration No. of Person Signing	Signature Date			
Total number of pages including cover sheet, attachments and documents: 2				

PATENT REEL: 026675 FRAME: 0071

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 24-14, Nishi Shinbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

FLUORESCENCE ANALYZING DEVICE AND FLUORESCENCE ANALYZING METHOD

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside signatures:

RECORDED: 07/29/2011

INVENTOR(C)

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
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4)	Takanobu HAGA Jakanobu Haga	7/7/2011
5)	Hirokazu KATO Birokyn Kcto	7/9/2011
6)	Nobutaka KUMAZAKI nobitata kanazahi	7/9/2011
7)	Takuya MATSUI Takuya Matsusi	7/5/2011
8)		
9)		
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